L Number	Hits	Search Text	DB	Time stamp
1	774608	radiate radiation radiated radiating	USPAT; US-PGPUB;	2004/08/06 08:03
2	472837	(control controlling controlled) with (terminal electrode)	EPO; JPO; DERWENT; IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/06 08:35
3	4901	<pre>(radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:05
4	591	(semiconductor chip die ic (integrated adj circuit)) same ((radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:20
5	40	<pre>(bump ball bga) and ((semiconductor chip die ic (integrated adj circuit)) same ((radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode)))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/06 08:21
6	1979	<pre>(stin (terminal electrode))) (semiconductor chip die ic (integrated adj circuit)) and ((radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode)))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:20
7	121	(bump ball bga) and ((semiconductor chip die ic (integrated adj circuit)) and ((radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:34
8	81	((bump ball bga) and ((semiconductor chip die ic (integrated adj circuit)) and ((radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode)))) not ((bump ball bga) and ((semiconductor chip die ic (integrated adj circuit)) same ((radiate radiation radiated radiating) same ((control controlling controlled) with (terminal electrode))))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 08:33
9	218	257/188	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:33
10	806	257/688	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:33
11	293	257/689	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/06 08:34
12	1221	257/188 257/688 257/689	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/08/06 08:34

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13	437	(bump ball bga) and (257/188 257/688	USPAT;	2004/08/06
		257/689)	US-PGPUB;	08:35
			EPO; JPO;	
			DERWENT;	
14	100	(t	IBM_TDB	2004/00/06
14	189	(control controlling controlled) and (bump ball bga) and (257/188 257/688	USPAT;	2004/08/06
			US-PGPUB;	09:00
		257/689))	EPO; JPO; DERWENT;	
			IBM TDB	
15	2	4620215.pn.	USPAT;	2004/08/06
13	2	4020213.pii.	US-PGPUB;	09:00
			EPO; JPO;	09.00
1			DERWENT;	
			IBM TDB	
16	1		USPĀT	2004/08/06
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17	1	,	USPAT	2004/08/06
				09:01
18	1		USPAT	2004/08/06
				09:02
19	1		USPAT	2004/08/06
				09:02
20	1		USPAT	2004/08/06
				09:02
21	1		USPAT	2004/08/06
22	1			09:02
22	1		USPAT	2004/08/06
23	1		Habam	09:02
23			USPAT	2004/08/06
24	1		USPAT	2004/08/06
			OSFAI	09:03
25	1		USPAT	2004/08/06
				09:03
26	1		USPAT	2004/08/06
		,		09:03
27	1		USPAT	2004/08/06
				09:03
28	1		USPAT	2004/08/06
				09:03